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Effect of sulfur substitution on the thermoelectric properties of (SnSe)_{1.16}NbSe₂: charge transfer in a misfit layered structure

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Misfit layered compounds have gained tremendous interest in the past couple of years due to the unique opportunities they offer for ZT enhancement arising from their phonon glass-electron crystal (PGEC) behavior. In this study we investigated the thermoelectric properties of polycrystalline layered misfit selenide (SnSe)_{1.16}NbSe₂ for the first time and tried to optimize its high hole concentration ($p \sim 9.6 \times 10^{-2}$ 10^{21} cm $^{-3}$) through sulfur (S) doping. The Seebeck coefficient, electrical resistivity, and thermal conductivity were measured in both directions, perpendicular (in-plane) and parallel (out-of-plane) to the pressing direction over the temperature range of 300 K to 760 K. S doping resulted in the decrease of hole concentration (p $\sim 4.0 \times 10^{21} \ {\rm cm^{-3}}$) and $\sim 50\%$ increase in hole mobility by increasing the charge transfer from SnSe to NbSe2 layer. This provided a 15% enhancement in power factor over the entire temperature range with a value of \sim 120 μ W K⁻² m⁻¹ at 760 K in the out-of-plane direction. These power factor values are still quite low for this misfit to be considered as a potential thermoelectric material. Further p optimization needs to be performed through charge transfer tuning in order to increase the power factor. For all the samples, the $\kappa_{\rm lat}$ is quite low and lies in the range from 0.9 to 2.3 W K^{-1} m⁻¹ in the out-of-plane direction at 760 K. Despite such low κ_{lat} , this Se misfit shows a poor maximum ZT (\sim 0.03 at 760 K) owing to high carrier concentration (low power factor). Nonetheless, this work provides further insights into the interdependence of electrical properties and charge transfer in misfit systems.

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Introduction

There is an ever increasing demand for sustainable clean energy technologies to overcome the energy crisis and to provide a promising solution to the global climate change. Thermoelectric power generation is one such technology that has been generating extensive interest, since it involves power generation from waste heat produced by various sources such as, automobiles, power plants, data centres *etc.* The efficiency of a thermoelectric device largely depends on the potential of the comprising p and n-type thermoelectric materials, which in turn is determined by their dimensionless thermoelectric figure of merit, $ZT = (S^2/\rho\kappa_{\rm total})T$, where S, ρ , $\kappa_{\rm total}$, and T are Seebeck coefficient, electrical resistivity, total thermal conductivity ($\kappa_{\rm total} = \kappa_{\rm el} + \kappa_{\rm lat}$; $\kappa_{\rm el}$ is electronic thermal conductivity and $\kappa_{\rm lat}$ is lattice thermal conductivity) and absolute temperature.

Many new concepts have been proposed to guide the search for novel thermoelectric materials and phonon glass-electron crystal (PGEC) concept¹ is among the prominent ones. In a PGEC material, the phonon glass region provides the disorder

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needed for phonon scattering (i.e., low κ_{latt}) without affecting the carrier mobility in the electron crystal region (i.e., high S^2/ρ), providing a perfect platform for ZT optimization. The most known examples of PGEC materials include filled skutterudites2 and clathrates³ consisting of rattling atoms, tetrahedrites with low energy vibration modes,4 nanocomposites consisting of coherently embedded nanoprecipitates,5-7 and layered systems such as superlattice thin films8 and layered oxides and chalcogenides9-13 where one layer serves as a carrier pathway and the other provides disorder. Misfit layered oxides such as Nax-CoO₂ 9,14 and Ca-Co-O^{10,11} have shown promising high temperature thermoelectric properties, however, their high electrical resistivity due to high electronegativity of oxygen still poses a limit for ZT enhancement. This brought misfit layered sulfides to the attention of the thermoelectric community since one can expect better power factor (S^2/ρ) owing to their lower electrical resistivity compared to oxides. 15 Misfit layered sulfides are a part of the family $(MX)_{1+m}(TX_2)_n$ (M = Pb, Bi, Sn, Sb, rareearth elements; T = Ti, V, Cr, Nb, Ta; X = S, Se; n = 1, 2, 3)^{16,17} and provide tremendous opportunities for ZT enhancement due to their PGEC behavior, where the CdI2-type TX2 host layer provides a passage for high-mobility carrier and the intercalated NaCl-type MX layer creates disorder and is responsible for

scattering phonons. The charge transfer from MX to TX₂ layer maintains the stability of the whole system.

The discovery of a large power factor ${\sim}3710~\mu\text{W K}^{-2}~\text{m}^{-1}$ in TiS₂ single crystal^{18,19} along with a high $\kappa_{total} \sim 6.7 \text{ W K}^{-1} \text{ m}^{-1}$ triggered an extensive research on its intercalated compounds where the guest transition metals or rock-salt-type MS layers (where M = Pb, Bi, or Sn) were intercalated into the van der Waals gap of layered TiS₂, with the aim of lowering its κ_{lat} . ^{20–23} Promising ZT values were reported for various intercalated sulfides such as, n-type $ZT \approx 0.45$ at 800 K for polycrystalline $Cu_{0.02}TiS_2$, ²¹ n-type $ZT \approx 0.38$ at 673 K for polycrystalline $(SnS)_{1,2}(TiS_2)_2$, op-type $ZT \approx 0.2$ at 950 K for $(La_{1,05}S_{1,05})_{1,14}$ NbS_{2} , and n-type $ZT \approx 0.14$ at 950 K for $(LaS)_{1,20}CrS_{2}$. Recently, organic intercalation has also been achieved in layered TiS₂ in order to form a flexible hybrid superlattice with ZT of 0.28 at 373 K.26 These studies show the potential of layered misfit sulfides as new generation thermoelectric materials. Layered misfit selenides, however, have not been explored yet for their temperature dependent thermoelectric performance.

In this study, we present an in-depth account of the high temperature thermoelectric properties of (SnSe)_{1,16}NbSe₂ or Sn_{1.16}NbSe_{3.16} misfit selenide. This compound has been studied by a few authors in the past for various aspects, such as, (1) its complex crystal structure27 which ensures low lattice thermal conductive like all other misfit layered chalcogenides, (2) synthesis and study of ferecrystalline alloys/thin films²⁸⁻³⁰ which have shown that charge transfer and hence the electronic properties in this misfit are tunable and, (3) polycrystalline room temperature electronic properties16,27 which indicate its low room temperature electrical resistivity (\sim 6 $\mu\Omega$ m). These previous studies make this misfit selenium compound a suitable candidate for thermoelectric investigation as well. In this study we also try to improve the thermoelectric performance of Sn_{1.16}NbSe_{3.16} misfit selenide by doping the Se site with S. Presence of mixed anion/cation have proven to be beneficial in terms of enhancing ZT³¹ and influencing the interlayer/ intralayer interactions³² for similar systems in the past.

2. Experimental

2.1 Synthesis and sintering

Elemental tin (Sn; 99.9999%, Kojundo Chemical Laboratory Co. Ltd), elemental niobium (Nb; 99.9%, Kojundo Chemical Laboratory Co. Ltd), elemental selenium (Se; 99.999%, Kojundo Chemical Laboratory Co. Ltd), and elemental sulfur (S; 99.999%, Kojundo Chemical Laboratory Co. Ltd) were used as starting materials without further purification. Powders (\sim 6 g) with nominal composition $Sn_{1.16}Nb(Se_{1-x}S_x)_{3.16}$ (x = 0, 0.1, 0.2) were synthesized by mixing appropriate ratios of starting materials of Sn, Nb, Se, and S in quartz tubes. For example, 1.775 g of Sn, 1.197 g of Nb, 2.895 g of Se, and 0.130 g of S were used to prepare 6 g of Sn_{1.16}Nb(Se_{0.9}S_{0.1})_{3.16}. The tubes were evacuated to 7×10^{-3} Pa and then sealed. They were heated to 673 K at a rate of 0.5 K min⁻¹ and held for 12 h, and further heated to 1023 K and held for 24 h. The samples were then cooled to room temperature over 12 h. The prepared powders were grinded and placed into 10 mm- or 15 mm-diameter

graphite dies which were then inserted into the sintering equipment (SPS-515S, Fuji Electronic Industrial) and heated at 14 K min $^{-1}$. Sintering was performed at 923 K for 1 h under 30 MPa uniaxial pressure in vacuum (7 \times 10 $^{-3}$ Pa) and subsequently cooled at 25 K min $^{-1}$ to prepare high density and oriented sintered compacts, which were cut into bars, disks, and plates for further measurements. The density of the sintered compacts was determined using the gas pycnometer method (Accu Pyc II 1340, Shimadzu) at room temperature. All samples showed a density >95% of the theoretical density.

2.2 Powder X-ray diffraction and scanning electron microscopy

The crystal structure of the powders and the grain orientation in the sintered compacts was examined using XRD (Rint-Ultima⁺, Rigaku) with Cu K α radiation over the 2θ range of $10\text{--}60^\circ$. Lattice parameters were refined by Le Bail decomposition to the powder XRD data using JANA2006 software.³³

The microstructure of the sintered compacts were observed using scanning electron microscopy (SEM, HITACHI, TM3030 Plus, Miniscope).

2.3 Electrical transport measurement

The Seebeck coefficient and electrical resistivity of the compact samples were simultaneously measured using temperature-differential and four probe methods, respectively, (ZEM-3, Advance Riko) perpendicular (in-plane) and parallel (out-of-plane) to the pressing direction under a He atmosphere over the temperature range of 300–773 K. The bars used for the in-plane and out-of-plane measurements typically were $\sim\!\!3$ mm $\times \sim\!\!2$ mm $\times \sim\!\!10$ mm and $\sim\!\!3$ mm $\times \sim\!\!2$ mm $\times \sim\!\!7$ mm, respectively. Seebeck coefficient and electrical resistivity were reproducible over heating and cooling cycles for both directions. The uncertainty of the Seebeck coefficient and electrical conductivity is estimated to be within $\sim\!\!5\%$.

The Hall coefficient of the sintered compacts was measured using a homemade system under a magnetic field from 0 to 2.3 T at room temperature. The samples typically were ~ 5 mm $\times \sim 5$ mm $\times \sim 0.3$ mm. In rich In–Ga paste was used to attach Cu contact wires to the samples. In our previous work we have confirmed the accuracy of our home made Hall measurement system by measuring the same samples using physical property measurement system (PPMS, Quantum Design).²⁵

2.4 Thermal transport measurement

The total thermal conductivity ($\kappa_{\rm total}$) was calculated using the density (d), the thermal diffusivity (D), the heat capacity ($C_{\rm P}$) of the sintered compacts, and the equation $\kappa_{\rm total} = DC_{\rm P}d$. The thermal diffusivity was directly measured and the heat capacity was indirectly derived using a standard sample (Pyroceram 9606) and laser flash method (LFA 457 MicroFlash, Netzsch) over the temperature range of 300–773 K under Ar flowing at 100 mL min⁻¹. The samples used for the out-of-plane measurements were typical \sim 10 mm diameter, \sim 2 mm thick coins, and those used for the in-plane measurements were 2 mm thick, \sim 6

 \times 6 mm square plates. The heating and cooling cycles enable the repeatable thermal diffusivity for all the sintered compacts.

The uncertainty of the thermal conductivity is estimated to be within 8%, taking into account the uncertainties of D, C_P , and d. The combined uncertainty for all measurements involved in the calculation of ZT is around 12%.

3. Results and discussions

3.1 Crystal structure and microstructure

Fig. 1a shows the X-ray diffraction (XRD) patterns of Sn_{1.16}-Nb(Se_{1-x}S_x)_{3.16} (x = 0, 0.1, 0.2) powder samples. Also shown are the reference peaks for comparison.²⁷ No impurity peaks attributable to secondary phases are detected for x = 0 and 0.1 samples, however, for x = 0.2, impurities of unidentifiable mixed phases can be observed. At this point, it couldn't be determined whether the S atom occupies Se sites in SnSe layer or NbSe₂ layer or both. However, the disappearance of many peaks corresponding to SnSe layer in Sn_{1.16}Nb(Se_{0.9}S_{0.1})_{3.16} (such as, $2\theta = 22.29^{\circ}$ [111], 25.64° [112], 42.55° [115], 43.60° [221], and 57.64 [225]) indicates a possibility of increased compositional disorder or defects in SnSe layer due to the introduction of multiple anions. This is expected since the NaCl type layer is known to be the most prone to any kind of disorder in misfit systems. 16,24,25 For a much accurate analysis and understanding of the compositions of various elements and the associated disorder in these samples, synchrotron X-ray diffraction experiments are required.

Table 1 shows the refined lattice parameters at room temperature for all the samples with typical refinement R values being, $R_{\rm p} \sim 6.8\%$ and $R_{\rm wp} \sim 9.7\%$. The $({\rm SnSe})_{1.16}{\rm NbSe}_2$ system is indexed as CF type, where SnSe and NbSe₂ layers have C and F centered orthorhombic lattices, respectively. Since this system is isostructural with $({\rm LaS})_{1.14}{\rm NbS}_2$, a similar approach of lattice refinement was followed using a (3+1)-dimensional superspace group Fm2m(p00)00s. Both layers have common b and c-axis, but incommensurate a-axis with the ratio of $p = a_{\rm NbSe_2}/a_{\rm SnSe}$, considering $({\rm Sn_2Se_2})_p{\rm NbSe_2}$. With the substitution of Se for S, all

Table 1 Lattice parameters of the SnSe and NbSe₂ subgroups for $Sn_{1.16}$ Nb($Se_{1-x}S_x$)_{3.16} (x=0, 0.1, 0.2)

ample	Subgroup	a (Å)	b (Å)	c (Å)
$Sn_{1.16}NbSe_{3.16} \\$	SnSe	6.1	6.1	12.7
	$NbSe_2$	3.6	6.1	25.3
$Sn_{1.16}Nb(Se_{0.9}S_{0.1})_{3.16}$	SnSe	5.9	5.9	12.2
	NbSe ₂	3.4	5.9	24.4
$Sn_{1.16}Nb(Se_{0.8}S_{0.2})_{3.16}$	SnSe	5.3	5.4	11.0
	$NbSe_2$	3.1	5.4	22.1
	NbSe ₂ SnSe	3.4 5.3	5.9 5.4	

the lattice parameters decrease considerably with \sim 3–4% reduction in case of x=0.1 to as high as \sim 12–13% for x=0.2 for both the layers, when compared with the pristine Se sample. This indicates that S might be occupying Se sites in both the layers. The reduction in lattice parameters is expected since S²–(1.84 Å for 6 coordination) has a smaller ionic radius than Se²–(1.98 Å for 6 coordination), and the presence of impurities (in x=0.2 sample) and deviation from the ideal configuration is bound to cause some kind of crystallographic strains on the lattice. The lattice parameters can also be affected by the changes in charge transfer between SnSe and NbSe₂ layers, which will be studied in the later section.

Fig. 1b shows the XRD patterns for the surfaces perpendicular (out-of-plane) to the pressing directions for all the sintered compacts. All the samples show a strong normalized orientation index of the (00*l*) plane, indicating that the crystalline *c*-axis is preferably oriented along the out-of-plane direction, as reported for other misfit layered systems. ^{20,25} The covalent bonding within the layers being much stronger than the interlayer bonding, causes the grains to grow in direction perpendicular to the pressure applied during sintering which gives the highly preferred (00*l*) orientation. The extent of grain orientation was analyzed using the peak intensity ratio $\sum I(00l)/\sum I(hkl)$. The pristine Se system showed the highest peak intensity ratio of 80% suggesting a highly oriented texture, followed by x = 0.1 with 73% and x = 0.2 with 61% with the least degree of orientation.

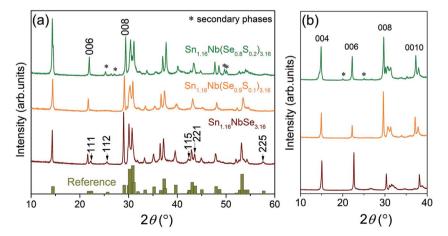


Fig. 1 (a) Powder X-ray diffraction (XRD) patterns for $Sn_{1.16}Nb(Se_{1-x}S_x)_{3.16}$ (x=0,0.1,0.2) along with the reference pattern.²⁷ (b) Out-of-plane XRD patterns for $Sn_{1.16}Nb(Se_{1-x}S_x)_{3.16}$ (x=0,0.1,0.2) sintered compacts.

The SEM images of the sintered compacts shown in Fig. 2 strongly support the XRD patterns in regards to orientation and layering of grains. The grains in Sn_{1,16}NbSe_{3,16} vary in size from 10 μm to 100 μm and are self-arranged into a layered structure (Fig. 2a). Fig. 2b provides a closer look at these sheets of grains. This natural layering of the grains is due to the anisotropic nature of the atomic bonds in these materials, as mentioned before. Sulfur doping, however, disrupts this preferential grain growth most likely due to the expected compositional disorder/ defects arising from the presence of mixed anions. Fig. 2c shows the SEM image of Sn_{1.16}Nb(Se_{0.9}S_{0.1})_{3.16} sample with grains \sim 20–30 μm in size with a slight orientation perpendicular to the pressing direction. This sample has a homogenous grain size distribution but lacks the layered ordering of the micrograins. For Sn_{1.16}Nb(Se_{0.8}S_{0.2})_{3.16}, no grain orientation is apparent in the SEM image, (Fig. 2d) and the grain size distribution also appears to be very inhomogeneous most probably due to the secondary phase impurities present in this sample. Even the slightest compositional changes in these misfit layered systems can greatly influence the grain growth, as studied comprehensively in our previous work on (LaS)1.14NbS2 system.24

3.2 Thermoelectric properties

The sintered density was confirmed to be higher than 95% of the theoretical density (6.32 g cm⁻³) for all the measured samples. Specifically, the density of Sn_{1.16}NbSe_{3.16}, Sn_{1.16}- $Nb(Se_{0.9}S_{0.1})_{3.16}$, and $Sn_{1.16}Nb(Se_{0.8}S_{0.2})_{3.16}$ is 6.19 g cm⁻³, 6.11 g cm⁻³, and 6.01 g cm⁻³, respectively. From the room temperature Hall effect measurements and assuming parabolic bands and single-band conduction, we estimated the hole concentration (p) and carrier mobility (μ) using the relation: $p = 1/eR_H$ and $\mu = 1/pe\rho$, where $R_{\rm H}$ is the Hall coefficient and e represents

electronic charge and ρ is electrical resistivity. Table 2 shows the $R_{\rm H}$, p and μ for all the samples. The sign of $R_{\rm H}$ and Seebeck coefficient (S, Fig. 3b) are positive for all the samples indicating conduction by holes. This misfit selenide exhibits p-type metallic conduction in a more than half filled 4dz2 band, with a slight electron transfer from SnSe to NbSe2 layer. 16,27 In $(MS)_{1+m}(TS_2)_n$ (M = Pb, Sn) misfits, the defects in the S lattice is proposed to be responsible for the slight charge (electron) transfer.16 A similar assumption can be made for our Se system as well, where the defects in the Se sites could be responsible for the slight charge transfer from the SnSe to the NbSe₂ layer and the conduction only determined by holes in the d₂2 band of NbSe₂.

We measured $R_{\rm H}\sim 0.7\times 10^{-9}~{\rm m^3~C^{-1}}$ and $p\sim 9.3\times 10^{21}$ cm⁻³ for pristine Se system, which is similar to the previously reported values ($R_{\rm H}\sim 0.6\times 10^{-9}~{
m m}^3~{
m C}^{-1}$ and $p\sim 9.6\times 10^{21}$ cm⁻³)²⁷ at room temperature. This value of p corresponds to 1.3 holes/Nb atoms. With the substitution of Se for S, p reduces to less than half with a value of $\sim 4 \times 10^{21}$ cm⁻³ corresponding to 0.5 holes/Nb atoms. The variation in holes/Nb atoms is known to be greatly affected by the extent of charge transfer with greater charge transfer leading to lower holes/Nb atoms.30 One assumption is that the substitution of Se for S increases the defects on the Se sites leading to excessive charge transfer from the SnSe layer to the NbSe₂ layer, hence decreasing the holes/Nb atom in the NbSe₂ layer. This assumption is also supported by the fact that μ of S doped samples is more than twice higher than the pristine Se system, even though the SEM images show better texturing of grains for the latter. For example, the inplane and out-of-plane μ of (SnSe)_{1.16}NbSe₂ is 1.7 and 1.1 cm² $V^{-1} \ s^{-1}$, whereas for $Sn_{1.16}Nb(Se_{0.9}S_{0.1})_{3.16}$ and $Sn_{1.16}Nb(Se_{0.8}-1)_{3.16}$ $(S_{0.2})_{3.16}$ the values are 4.5 and 2.7 cm² V⁻¹ s⁻¹; 3.9 and 2.6 cm²

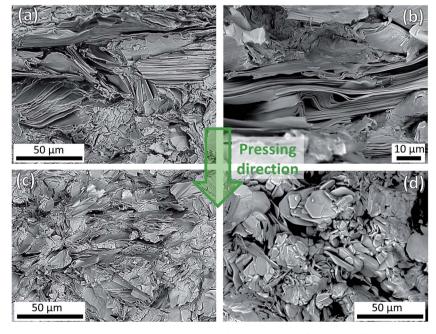


Fig. 2 Scanning electron micrographs of the fractured areas of (a and b) $Sn_{1.16}NbSe_{3.16}$, (c) $Sn_{1.16}Nb(Se_{0.9}S_{0.1})_{3.16}$ and (d) $Sn_{1.16}Nb(Se_{0.8}S_{0.2})_{3.16}$ sintered compacts.

Table 2 Room temperature Hall coefficient (R_H), carrier concentration (p), hole mobility (μ), and effective mass (m^*) measured perpendicular (inplane) and parallel (out-of-plane) for the $Sn_{1.16}Nb(Se_{1-x}S_x)_{3.16}$ (x = 0, 0.1, 0.2) sintered compacts

Sample	Direction	$R_{\rm H}$ (10 ⁹ m ³ C ⁻¹)	$p (10^{21} \text{ cm}^{-3})$	$\mu (\text{cm}^2 \text{V}^{-1} \text{s}^{-1})$	m^*/m^0
$Sn_{1.16}NbSe_{3.16}$	In-plane	0.7	9.3	1.7	1.9
	Out-of-plane			1.1	3.2
$Sn_{1.16}Nb(Se_{0.9}S_{0.1})_{3.16}$	In-plane	1.6	4.0	4.5	0.9
	Out-of-plane			2.7	2.0
$Sn_{1.16}Nb(Se_{0.8}S_{0.2})_{3.16}$	In-plane	1.4	4.2	3.9	1.0
	Out-of-plane			2.6	2.0

V⁻¹ s⁻¹, respectively. Higher charge transfer increases the strength of inter and intra layer bonding which can promote the better mobility of the charge carriers and also play a role in the decrease of the lattice parameters,32 which we also observe in Table 1.

The temperature dependence of electrical resistivity (ρ) and Seebeck coefficient (S) are shown in Fig. 3a and b, respectively. The samples exhibit a metallic behavior where ρ and S increase with temperature. As expected, the ρ of all the samples are highly anisotropic in accordance with the mobility (Table 2) trends. The oriented textures promote higher μ (1.7-4.5 cm² V⁻¹ s⁻¹) and lower ρ (3.8–3.4 $\mu\Omega$ m) in the in-plane direction, while increased carrier scattering at the interfaces between the layers results in a lower μ (1.1–2.7 cm² V⁻¹ s⁻¹) and ~40% larger ρ (6.2–5.6 $\mu\Omega$ m) in the out-of-plane direction, for all the samples at room temperature. In general, the ρ of S containing samples

is lower than the pristine Se system mainly due to higher carrier mobility in the former. The room temperature ρ values of our samples are similar to the ferecrystalline (SnSe)_{1.16}NbSe₂ (ref. 30) and its VSe₂ variant, 35 but is twice lower than its n-type TiSe₂ variant (12-15 $\mu\Omega$ m).³⁶

The $Sn_{1.16}Nb(Se_{0.9}S_{0.1})_{3.16}$ sample shows the highest S almost over the entire temperature range owing to its lower p with a value of $\sim 16 \,\mu\text{V K}^{-1}$ at room temperature, peaking at 760 K to $\sim 30 \text{ µV K}^{-1}$, followed by pristine (SnSe)_{1.16}NbSe₂ sample with \sim 14 µV K⁻¹ at room temperature and \sim 31 µV K⁻¹ at 760 K, in out-of-plane direction (Fig. 3b). These S values in general are much lower compared to the sulfide misfit systems (\sim 50–170 μ V K⁻¹ above 700 K)^{20,23} and do not lie in the range for good thermoelectric materials.

All the samples show anisotropic *S* in the whole temperature range measured; the in-plane S values are smaller (7–9 μ V K⁻¹)

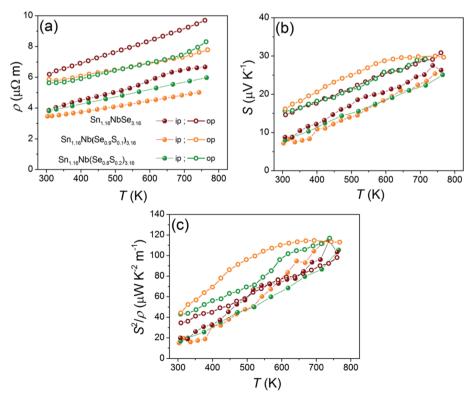


Fig. 3 Temperature dependencies of the (a) electrical resistivity (ρ), (b) Seebeck coefficient (S), and (c) power factor (S^2/ρ) measured perpendicular (in-plane (ip)) and parallel (out-of-plane (op)) to the pressing direction for the $Sn_{1.16}Nb(Se_{1-x}S_x)_{3.16}$ (x=0, 0.1, 0.2) sintered compacts.

than the out-of-plane ones (14–16 μ V K⁻¹) (Fig. 3b). To analyze this anisotropy, we estimated the carrier (hole) effective mass m^* from the measured n and S using the following relation.

$$S = \frac{8\pi^2 k_{\rm B}^2}{3eh^2} m^* T \left(\frac{\pi}{3p}\right)^{2/3} \tag{1}$$

here $k_{\rm B}$ is Boltzmann's constant and h is plank's constant. The m^* values are listed in Table 2 and lie in the range 0.9-3.2 m_0 (where m_0 is free electron mass). These values are slightly larger than reported for misfit rare earth sulfides $(0.7-2.2m_0)^{24}$ and much smaller compared to the misfit sulfides $(MS)_{1+x}(TiS_2)_2$ $(MS)_{1+x}(TiS_2)_2$ = Pb, Bi, Sn) $(4.5-6.3m_0)^{20}$ The m^* for S doped samples is 40-50% smaller compared to the pristine Se system, which could also be related to the excess charge transfer and strong inter/ intra layer bonding in the former, as discussed above. The anisotropy in m^* and S has been observed before in (LaS)_{1,14}-NbS₂ (ref. 24) and (SnS)_{1.2}(TiS₂)³⁷ and was thought to be a result of anisotropic band structure.17

As shown in Fig. 3c, $Sn_{1.16}Nb(Se_{0.9}S_{0.1})_{3.16}$ shows the highest power factor, S^2/ρ , in out-of-plane direction in the entire temperature range with a value of \sim 40 μ W K⁻² m⁻¹ at 300 K and \sim 120 μ W K⁻² m⁻¹ at 760 K, which is about \sim 15% improvement compared to the pristine Se system. The former has higher S^2/ρ due to higher μ (low ρ) and lower p (high S), compared to the latter. In general, the S^2/ρ values are higher in the out-of-plane directions than in the in-plane direction due to higher m^* for all the samples in the out-of-plane direction. Although the introduction of S in Se site has proven beneficial in improving the S^2 / ρ of this system, the values are still much (2–3 times) lower compared with misfit layered sulfides reported in the past²³ which is mostly due to a magnitude higher carrier concentration in our Se misfit system.

Fig. 4a and b shows the temperature dependences of the total thermal conductivity (κ_{total}) and lattice thermal conductivity (κ_{lat}) determined by subtracting electronic thermal conductivity (κ_{el}) from κ_{total} of $Sn_{1.16}Nb(Se_{1-x}S_x)_{3.16}$ (x=0, 0.1,0.2) in both the directions, respectively. The $\kappa_{\rm el}$ was estimated using the Wiedemann–Franz law given as $\kappa_{\rm el} = LT/\rho$, where *L* is the Lorenz number (2.44 \times 10⁻⁸ W Ω K⁻²). For all the samples in both directions, the κ_{total} and κ_{lat} are quite low and lie in the ranges from 3.0 to 5.4 W K^{-1} m⁻¹ and 0.9 to 2.3 W K^{-1} m⁻¹ at 760 K, respectively, with in-plane values being higher than the out-of-plane ones. This is because the interfaces between the layers effectively scatter the longer wavelength heat-carrying phonons, as is expected in layered systems. However, the κ_{lat} of these misfit selenides are slightly higher than for misfit sulfides $(0.3-1.9 \text{ W K}^{-1} \text{ m}^{-1} \text{ at high temperatures})$, which adds to their disadvantage. For pristine Sn_{1.16}NbSe_{3.16} sample, the difference between its in-plane (~2.3 W K⁻¹ m⁻¹) and out-ofplane (\sim 1.0 W K⁻¹ m⁻¹) κ_{lat} is the largest with the former being twice larger at 760 K and is due to the increased interlayer and boundary scatterings arising from strong orientation of grains (as observed through SEM). S doping disrupts the strong grain orientation and also results in a smaller grain size, owing to which $Sn_{1.16}Nb(Se_{0.9}S_{0.1})_{3.16}$ and $Sn_{1.16}Nb(Se_{0.8}S_{0.2})_{3.16}$ have a much lower in-plane κ_{lat} (\sim 1.8 W K⁻¹ m⁻¹ and \sim 1.1 W K⁻¹ m^{-1} , respectively). The additional impurities in $\mathrm{Sn}_{1.16}\mathrm{Nb}(\mathrm{Se}_{0.8} S_{0,2}$ _{3,16} must also contribute towards its low κ_{lat} .

The thermoelectric figure of merit (ZT) for the misfit layered selenides, $Sn_{1.16}Nb(Se_{1-x}S_x)_{3.16}$ (x = 0, 0.1, 0.2), in the in-plane and out-of-plane directions calculated from the measured ρ , S, and κ_{total} are shown in Fig. 5. $\text{Sn}_{1.16}\text{Nb}(\text{Se}_{0.9}\text{S}_{0.1})_{3.16}$ has the highest ZT in the whole temperature range with a value of \sim 0.03

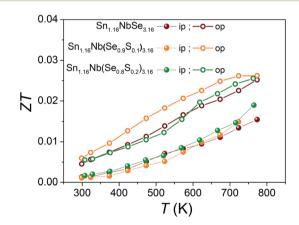


Fig. 5 Temperature dependence of the thermoelectric figure of merit (ZT) measured perpendicular (in-plane (ip)) and parallel (out-of-plane (op)) to the pressing direction for the $Sn_{1.16}Nb(Se_{1-x}S_x)_{3.16}$ (x = 0, 0.1, 0.2) sintered compacts.

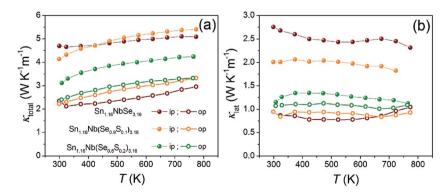


Fig. 4 Temperature dependencies of (a) total thermal conductivity (κ_{total}), and (b) lattice thermal conductivity (κ_{lat}) measured perpendicular (inplane (ip)) and parallel (out-of-plane (op)) to the pressing direction for the $Sn_{1.16}Nb(Se_{1-x}S_x)_{3.16}$ (x=0, 0.1, 0.2) sintered compacts.

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at 760 K, mainly due its higher S^2/ρ compared to the other samples. These ZT values are very low for this selenide system to be considered as a potential thermoelectric material, mainly due to the high hole concentration in the system. In order to enhance ZT, further carrier concentration optimization needs to be performed on this system. One way, is to synthesize compound with paired NbSe₂ layers (for example, (SnSe)_{1.16}(-NbSe₂)_n, n = 2, 3) to tune the charge transfer which could ultimately lead to lower p. Proper doping on anion or cation sites as well as studying the effects of non-stoichiometry can also be useful in enhancing the thermoelectric properties of this Se misfit system.

Conclusion 4.

Here, we synthesized bulk polycrystalline misfit layered selenides $Sn_{1.16}Nb(Se_{1-x}S_x)_{3.16}$ (x = 0, 0.1, 0.2) and studied their temperature dependent thermoelectric properties for the first time. S doping was performed to improve the thermoelectric properties of the system. S doping seemed to increase the charge transfer from the SnSe to NbSe2 layers, thereby reducing the hole concentration and increasing the hole mobility in the system. This resulted in slightly higher S and lower ρ , owing to which 15% higher $S^2/\rho \sim 120~\mu W~K^{-2}~m^{-1}$ at 760 K was achieved for S doped system compared to the pristine Se system, in out-of-plane direction. For all the samples, the κ_{lat} is quite low and lie in the ranges from 0.9 to 2.3 W K^{-1} m⁻¹ in the out-of-plane direction at 760 K. Despite such low κ_{lat} , this Se misfit shows poor maximum ZT (~ 0.03 at 760 K) due to its low S^2/ρ arising from high hole concentration. Further carrier concentration optimizations need to be performed on this system through relevant dopings or making compound with paired NbSe2 layers. At the same time, other Se misfit compounds should be explored, such as TiSe₂, VSe2, CrSe2, TaSe2 host layer compounds and rare-earth intercalation compounds, in order to determine the true potential of layered Se misfits for thermoelectrics.

Author contributions

P. J. and M. O. designed the experiments. P. J. prepared the powders and sintered samples and performed the XRD experiments and measured the electrical and thermal transport properties. Both authors discussed the results and contributed to writing of the manuscript.

Conflict of interest

The authors have declared no conflicts of interest.

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